Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2016. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC). Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment).

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Please note that TAIYO YUDEN shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from use of our products. TAIYO YUDEN grants no license for such rights.
- Please note that unless otherwise agreed in writing, the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE)

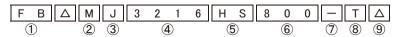




■PARTS NUMBER

*Operating Temp. : -40~+125°C (Including self-generated heat)

△=Blank space



①Series name

Code	Series name
FB	Ferrite bead

2Shape

Conapc			
Code	Shape		
M	Rectangular chip		

3 Characteristics

-	
Code	Characteristics
J	Standard
Н	High Impedance type

4)Dimensions (L × W)

- Difficiations (E × W)				
Code	Type (inch)	Dimensions (L×W)[mm]		
1608	1608(0603)	1.6 × 0.8		
2125	2125(0805)	2.0 × 1.25		
2012	2012(0805)	2.0 × 1.25		
2016	2016(0806)	2.0 × 1.6		
3216	3216(1206)	3.2 × 1.6		
3225	3225(1210)	3.2 × 2.5		
4516	4516(1806)	4.5 × 1.6		
4525	4525(1810)	4.5 × 2.5		
4532	4532(1812)	4.5 × 3.2		

(5) Material

Code	Material
HS	Defeate impedance survey
НМ	Refer to impedance curves for material differences
HL	for material differences

6 Nominal impedance

Code (example)	Nominal impedance [Ω]
330	33
221	220
102	1000

7Impedance tolerance

Code	Impedance tolerance	
_	±25%	
N	±30%	

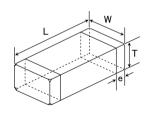
8 Packaging

Code	Packaging
Т Т	Taning

9Internal code

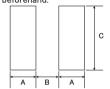
O	
Code	Internal code
Δ	Standard

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns Surface Mounting

• Mounting and soldering conditions should be checked beforehand.



Type	Α	В	С
FB MJ1608	1.0	1.0	1.0
FB MJ2125	1.4	1.2	1.65
FB MJ3216	1.4	2.2	2.0
FB MJ4516	1.75	3.5	2.0
FB MH1608	1.0	1.0	1.0
FB MH2012	1.4	1.2	1.65
FB MH2016	1.4	1.2	2.0
FB MH3216	1.4	2.2	2.0
FB MH3225	1.4	2.2	2.9
FB MH4516	1.75	3.5	2.0
FB MH4525	1.75	3.5	2.9
FB MH4532	1.75	3.5	3.7

Unit:mm

Type	1	W	Т		Standard qu	antity [pcs]
Type	_	VV		е	Paper tape	Embossed tape
FB MJ1608	1.6±0.2	0.8 ± 0.2	0.8 ± 0.2	0.3±0.2	4000	
(0603)	(0.063 ± 0.008)	(0.031 ± 0.008)	(0.031 ± 0.008)	(0.012 ± 0.008)	4000	_
FB MJ2125	2.0±0.2	1.25±0.2	0.85 ± 0.2	0.5 ± 0.3	4000	
(0805)	(0.079 ± 0.008)	(0.049 ± 0.008)	(0.033 ± 0.008)	(0.020 ± 0.012)	4000	_
FB MJ3216	3.2±0.3	1.6±0.2	1.1 ± 0.2	0.5 ± 0.3	_	2000
(1206)	(0.126 ± 0.012)	(0.063 ± 0.008)	(0.043 ± 0.008)	(0.020 ± 0.012)	_	2000
FB MJ4516	4.5±0.3	1.6±0.2	1.1 ± 0.2	0.5 ± 0.3	_	2000
(1806)	(0.177 ± 0.012)	(0.063 ± 0.008)	(0.043 ± 0.008)	(0.020 ± 0.012)		2000
FB MH1608	1.6±0.1	0.8 ± 0.1	0.8 ± 0.1	0.3 ± 0.15	4000	_
(0603)	(0.063 ± 0.004)	(0.031 ± 0.004)	(0.031 ± 0.004)	(0.012 ± 0.006)	4000	
FB MH2012	2.0 ± 0.2	1.25 ± 0.2	0.85 ± 0.2	0.5±0.3	4000	
(0805)	(0.079 ± 0.008)	(0.049 ± 0.008)	(0.033 ± 0.008)	(0.020 ± 0.012)	4000	_
FB MH2016	2.0 ± 0.2	1.6 ± 0.2	1.6 ± 0.2	0.5 ± 0.3	_	2000
(0806)	(0.079 ± 0.008)	(0.063 ± 0.008)	(0.063 ± 0.008)	(0.020 ± 0.012)	_	2000
FB MH3216	3.2±0.3	1.6±0.2	1.6±0.2	0.5 ± 0.3	_	2000
(1206)	(0.126 ± 0.012)	(0.063 ± 0.008)	(0.063 ± 0.008)	(0.020 ± 0.012)		2000
FB MH3225	3.2 ± 0.3	2.5 ± 0.3	2.5 ± 0.3	0.5 ± 0.3	_	1000
(1210)	(0.126 ± 0.012)	(0.098 ± 0.012)	(0.098 ± 0.012)	(0.020 ± 0.012)		1000
FB MH4516	4.5±0.3	1.6 ± 0.2	1.6 ± 0.2	0.5 ± 0.3	_	2000
(1806)	(0.177 ± 0.012)	(0.063 ± 0.008)	(0.063 ± 0.008)	(0.020 ± 0.012)		2000
FB MH4525	4.5±0.4	2.5 ± 0.3	2.5 ± 0.3	0.9 ± 0.6	_	1000
(1810)	(0.177 ± 0.016)	(0.098 ± 0.012)	(0.098 ± 0.012)	(0.035 ± 0.024)		1000
FB MH4532	4.5±0.4	3.2 ± 0.3	3.2 ± 0.3	0.9 ± 0.6		2000
(1812)	(0.177 ± 0.016)	(0.126 ± 0.012)	(0.126 ± 0.012)	(0.035 ± 0.024)		2000

Unit:mm(inch)

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Standard type

FR	M. 11	ണ

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ1608HS280NT	RoHS	28	±30%	100	0.007	4.0	0.8 ±0.2
FB MJ1608HM230NT	R₀HS	23	±30%	100	0.007	4.0	0.8 ±0.2

●FB MJ2125

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ2125HS250NT	RoHS	25	±30%	100	0.004	6.0	0.85 ±0.2
FB MJ2125HS420-T	RoHS	42	±25%	100	0.008	4.0	0.85 ±0.2
FB MJ2125HM210NT	R₀HS	21	±30%	100	0.004	6.0	0.85 ±0.2
FB MJ2125HM330-T	R₀HS	33	±25%	100	0.008	4.0	0.85 ±0.2
FB MJ2125HL8R0NT	R ₀ HS	8	±30%	100	0.008	4.0	0.85 ±0.2

●FB MJ3216

	Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FI	3 MJ3216HS480NT	RoHS	48	±30%	100	0.005	6.0	1.1 ±0.2
FI	3 MJ3216HS800-T	RoHS	80	±25%	100	0.010	4.0	1.1 ±0.2
FI	3 MJ3216HM380NT	RoHS	38	±30%	100	0.005	6.0	1.1 ±0.2
FI	B MJ3216HM600-T	RoHS	60	±25%	100	0.010	4.0	1.1 ±0.2
FI	3 MJ3216HL160NT	RoHS	16	±30%	100	0.012	4.0	1.1 ±0.2

FB MJ4516

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ4516HS720NT	RoHS	72	±30%	100	0.007	6.0	1.1 ±0.2
FB MJ4516HS111-T	RoHS	110	±25%	100	0.014	4.0	1.1 ±0.2
FB MJ4516HM560NT	RoHS	56	±30%	100	0.007	6.0	1.1 ±0.2
FB MJ4516HM900-T	RoHS	90	±25%	100	0.014	4.0	1.1 ±0.2
FB MJ4516HL230NT	RoHS	23	±30%	100	0.014	3.5	1.1 ±0.2

High impedance type

GHz Band

_	•	
FB	MH1608	

●FB MH1608								
Parts number	EHS	Nominal impedance Measuring frequency 100[MHz]		Nominal impe Measuring frequer		DC Resistance	Rated current [A] (max.)	Thickness [mm]
		(Ω)	tolerance	(Ω)	tolerance	E 2E 3 (maxi)	Erij (mara)	22
FB MH1608HM470-T	RoHS	47	±25%	75	±40%	0.020	3.5	0.8 ±0.1
FB MH1608HM600-T	RoHS	60	±25%	100	±40%	0.025	3.0	0.8 ±0.1
FB MH1608HM101-T	RoHS	100	±25%	170	±40%	0.035	2.5	0.8 ±0.1
FB MH1608HM151-T	RoHS	150	±25%	270	±40%	0.050	2.1	0.8 ±0.1
FB MH1608HM221-T	RoHS	220	±25%	370	±40%	0.070	1.8	0.8 ±0.1
FB MH1608HM331-T	RoHS	330	±25%	520	±40%	0.130	1.2	0.8 ±0.1
FB MH1608HM471-T	RoHS	470	±25%	750	±40%	0.150	1.0	0.8 ±0.1
FB MH1608HM601-T	RoHS	600	±25%	900	±40%	0.170	0.9	0.8 ±0.1
FB MH1608HM102-T	RoHS	1000	±25%	1200	±40%	0.350	0.6	0.8 ±0.1
FB MH1608HL300-T	RoHS	30	±25%	120	±40%	0.028	2.6	0.8 ±0.1
FB MH1608HL600-T	RoHS	60	±25%	220	±40%	0.045	2.1	0.8 ±0.1
FB MH1608HL121-T	RoHS	120	±25%	540	±40%	0.130	1.2	0.8 ±0.1
FB MH1608HL221-T	RoHS	220	±25%	950	±40%	0.170	0.9	0.8 ±0.1
FB MH1608HL331-T	RoHS	330	±25%	1200	±40%	0.210	0.8	0.8 ±0.1
FB MH1608HL471-T	RoHS	470	±25%	1500	±40%	0.350	0.6	0.8 ±0.1
FB MH1608HL601-T	RoHS	600	±25%	1800	±40%	0.450	0.5	0.8 ±0.1

High impedance type

●FB MH2012

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH2012HM800-T	RoHS	80	±25%	100	0.025	2.7	0.85 ± 0.2
FB MH2012HM121-T	RoHS	120	±25%	100	0.032	2.5	0.85 ±0.2
FB MH2012HM221-T	RoHS	220	±25%	100	0.060	2.0	0.85 ±0.2
FB MH2012HM331-T	RoHS	330	±25%	100	0.080	1.8	0.85 ± 0.2

●FB MH2016

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH2016HM121NT	RoHS	120	±30%	100	0.015	4.5	1.6 ±0.2
FB MH2016HM251NT	RoHS	250	±30%	100	0.050	2.0	1.6 ±0.2

●FB MH3216

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH3216HM221NT	RoHS	220	±30%	100	0.020	4.0	1.6 ±0.2
FB MH3216HM501NT	RoHS	500	±30%	100	0.070	2.0	1.6 ±0.2

●FB MH3225

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH3225HM601NT	RoHS	600	±30%	100	0.042	3.0	2.5 ±0.3
FB MH3225HM102NT	RoHS	1000	±30%	100	0.100	2.0	2.5 ±0.3
FB MH3225HM202NT	RoHS	2000	±30%	100	0.130	1.2	2.5 ±0.3

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●FB MH4516

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH4516HM851NT	RoHS	850	±30%	100	0.100	1.5	1.6 ±0.2

●FB MH4525

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]
FB MH4525HM102NT	RoHS	1000	±30%	100	0.060	3.0	2.5 ±0.3
FB MH4525HM162NT	RoHS	1600	±30%	100	0.130	2.0	2.5 ±0.3

●FB MH4532

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MH4532HM681-T	RoHS	680	±25%	100	0.028	4.0	3.2 ±0.3
FB MH4532HM132-T	RoHS	1300	±25%	100	0.060	3.0	3.2 ± 0.3
FB MH4532HM202-T	RoHS	2000	±25%	100	0.130	1.3	3.2 ±0.3

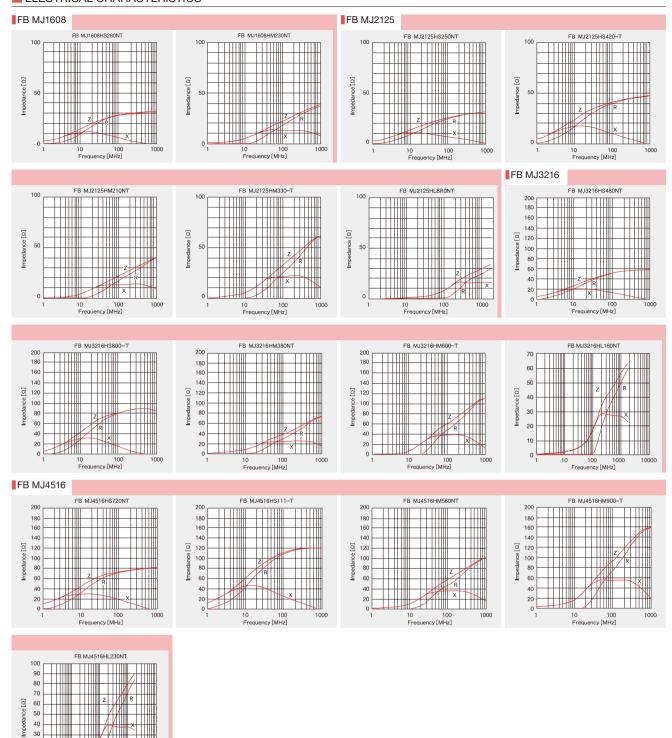
High current type

Parts number	EHS	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]
FB MJ1608HS220NTR	RoHS	22	±30%	100	0.004	7.5	0.8 ±0.2
FB MJ1608HS280NTR	RoHS	28	±30%	100	0.006	6.0	0.8 ±0.2
FB MJ1608HM180NTR	RoHS	18	±30%	100	0.004	7.5	0.8 ±0.2
FB MJ1608HM230NTR	RoHS	23	±30%	100	0.006	6.0	0.8 ±0.2

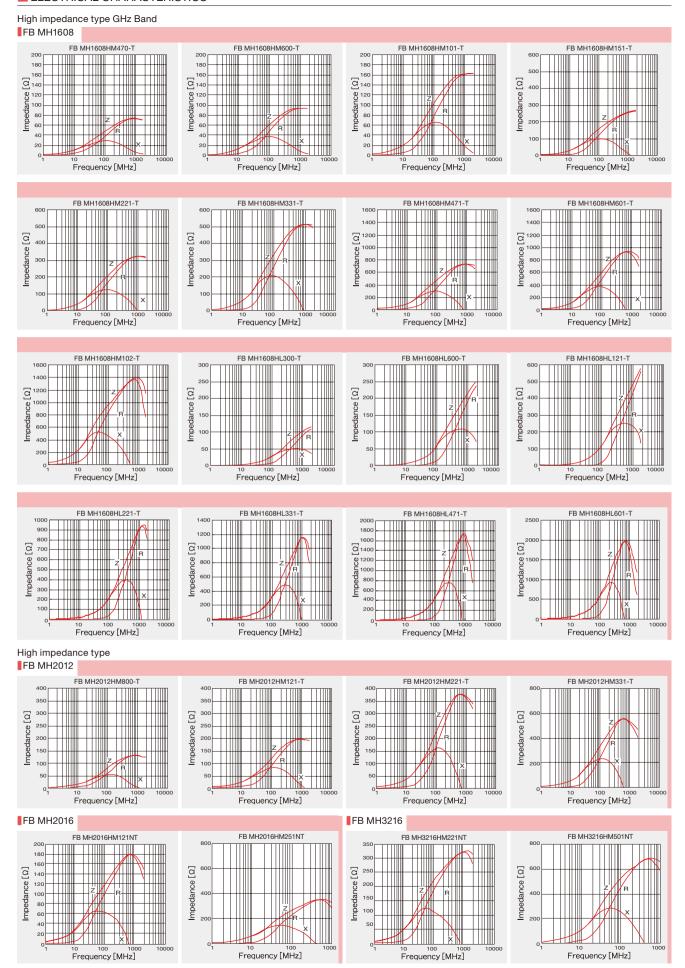
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40 30 20

100 1000 Frequency [MHz]

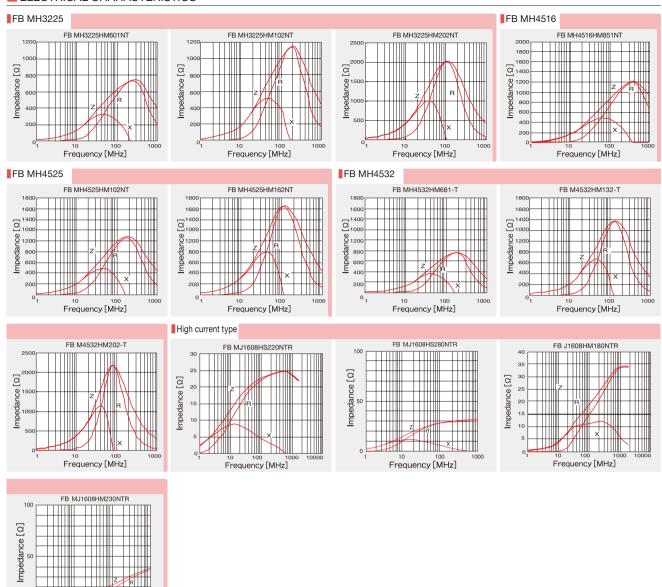


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Frequency [MHz]



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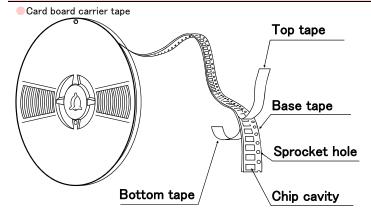
CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE)

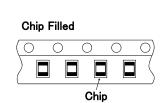
■PACKAGING

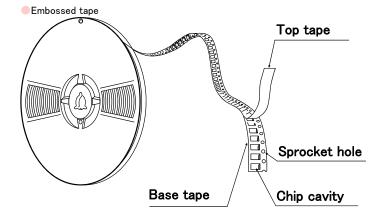
1 Minimum Quantity

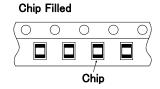
Type	Standard Quantity[pcs]			
туре	Paper Tape	Embossed Tape		
1608 (0603)	4000	1		
2125(0805)	4000	1		
2012 (0805)	4000	1		
2016 (0806)	_	2000		
3216(1206)	_	2000		
3225(1210)	_	1000		
4516 (1806)	_	2000		
4525(1810)	_	1000		
4532(1812)	_	2000		

2 Tape Material



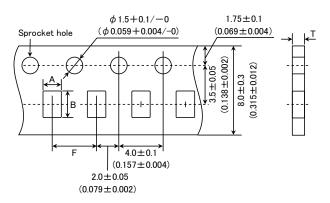






3Taping Dimensions

Paper tape (0.315 inches wide)

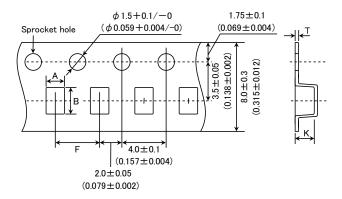


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Time	Chip (Chip Cavity		Tape Thickness
Туре	Α	В	F	T
FBMJ1608 FBMH1608 (0603)	1.0±0.2 (0.039±0.008)	1.8±0.2 (0.071±0.008)	4.0±0.2 (0.157±0.008)	1.1max (0.043max)
FBMJ2125 FBMH2012 (0805)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.2 (0.157±0.008)	1.1max (0.043max)

Unit: mm(inch)

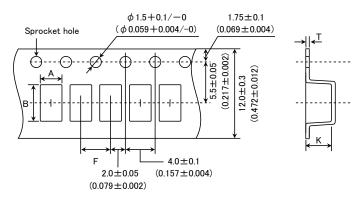
Embossed tape (0.315 inches wide)



Туре	Chip Cavity		Insertion Pitch	Tape Thickness	
туре	Α	В	F	K	Т
FBMH2016	1.8±0.2	2.2±0.2	4.0±0.2	2.6max	0.6max
(0806)	(0.071 ± 0.008)	(0.087 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FBMJ3216	1.9±0.2	3.5±0.2	4.0±0.2	1.5max	0.3max
(1206)	(0.075 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.059max)	(0.012max)
FBMH3216	1.9±0.2	3.5±0.2	4.0±0.2	2.6max	0.6max
(1206)	(0.075 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FBMH3225	2.8±0.2	3.5±0.2	4.0±0.2	4.0max	0.6max
(1210)	(0.110 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.157max)	(0.024max)

Unit: mm(inch)

Embossed tape (0.472 inches wide)

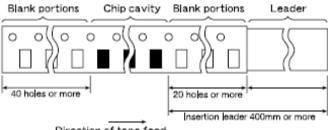


Туре	Chip Cavity		Insertion Pitch	Tape Thickness	
туре	Α	В	F	K	Т
FBMJ4516	1.9±0.2	4.9 ± 0.2	4.0±0.2	1.5max	0.3max
(1806)	(0.075 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.059max)	(0.012max)
FBMH4516	1.9±0.2	4.9±0.2	4.0±0.2	2.6max	0.6max
(1806)	(0.075 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FBMH4525	2.9±0.2	4.9±0.2	4.0±0.2	4.0max	0.6max
(1810)	(0.114 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.157max)	(0.024max)
FBMH4532	3.6±0.2	4.9±0.2	8.0±0.2	4.0max	0.6max
(1812)	(0.142 ± 0.008)	(0.193 ± 0.008)	(0.315 ± 0.008)	(0.157max)	(0.024max)

Unit: mm(inch)

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4 Leader and Blank portion

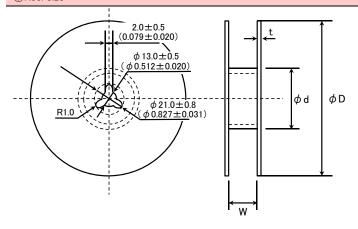


Direction of tape feed

Insertion leader is 400 mm or more (including 20 empty cavities)

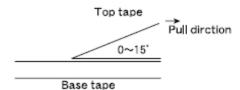
Empty cavities at end of reel: 40 holes or more

⑤Reel size



Туре	φD	ϕ d	W	t
FBMJ1608			10.0±1.5	
FBMJ2125			(0.394 ± 0.059)	
FBMJ3216			(0.394 ± 0.039)	
FBMJ4516			14.0±1.5 (0.551±0.059)	
FBMH1608	180+0/-3	60+1/-0		2.5max
FBMH2012	(7.09+0/-0.118)	(2.36+0.039/-0)	10.0±1.5	(0.098max)
FBMH2016			(0.394 ± 0.059)	
FBMH3216			(0.394±0.039)	
FBMH3225				
FBMH4516			14.0±1.5	
FBMH4525			(0.551 ± 0.059)	
EDMU4522	330±2.0	100±1.0	14.0±2.0	3.0max
FBMH4532	(12.99 ± 0.080)	(3.94 ± 0.039)	(0.551 ± 0.080)	(1.181max)
				Unit : mm(inch)

⑥Top tape strength



The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.

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CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE)

■RELIABILITY DATA

1. Operating Tempe	rature Range
Specified Value	-40°C~+125°C Including self-generated heat
2. Storage Tempera	ture Range
Specified Value	-40°C∼+85°C
Test Methods and Remarks	*Note: -5 to +40°C in taped packaging
3. Impedance	
Specified Value	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A) or its equivalent Measuring frequency : 100±1 MHz
4. DC Resistance	
Specified Value	Within the specified range
Test Methods and Remarks	Four-terminal method Measuring equipment : Milliohm High-Tester 3226 (Hioki Denki) or its equivalent
5. Rated Current	
Specified Value	Within the specified range
6. Vibration	
Specified Value	Appearance : No significant abnormality Impedance change : Within ±30% of the initial value
Test Methods and Remarks	According to JIS C60068-2-6. Vibration type : A Time : 2 hrs each in X,Y, and Z directions Total: 6 hrs Frequency range : 10 to 55 to 10Hz (/min.) Amplitude : 1.5 mm (shall not exceed acceleration 196m/s²) Mounting method : Soldering onto PC board
7. Solderability	
Specified Value	90% or more of immersed surface of terminal electrode shall be covered with fresh solder.
Test Methods and Remarks	Solder temperature : 230±5°C Immersion time : 4±1 sec. Preconditioning : Immersion into flux. Immersion and Removal speed : 25mm/sec.
8. Resistance to So	Idering Heat
Specified Value	Appearance : No significant abnormality Impedance change : Within ±30% of the initial value
Test Methods and Remarks	Preheating : 150°C for 3 min. Resistance to Soldering Heat : 260±5°C Duration : 10±0.5 sec. Preconditioning : Immersion and Removal speed : 25mm/sec.

Recovery

: 2 to 3 hrs of recovery under the standard condition after the test.

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9. Thermal Shock : No significant abnormality Appearance Specified Value : Within $\pm 50/-10\%$ of the initial value Impedance change According to JIS C60068-2-14. Conditions for 1 cycle Temperature (°C) Duration (min.) Step -40±3°C 30 ± 3 2 Room Temperature Within 3 Test Methods and 3 85±2°C 30±3 Remarks 4 Room Temperature Within 3 Number of cycles : 100 Mounting method : Soldering onto PC board Recovery : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.

10. Resistance to H	10. Resistance to Humidity (steady state)				
Specified Value	Appearances Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value			
Test Methods and Remarks	Temperature Humidity Duration Mounting method Recovery	: $40\pm2^{\circ}$ C : 90 to 95% RH : $500+24/-0$: Soldering onto PC board : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.			

11. Loading under D	amp Heat	
Specified Value	Appearance	No significant abnormality
	Impedance change	Within ±30% of the initial value
	Temperature	: 40±2°C
	Humidity	: 90 to 95%RH
Test Methods and	Applied current	: Rated current
Remarks	Duration	: 500+24/0 hrs
	Mounting method	: Soldering onto PC board
	Recovery	: 2 to 3hrs of recovery under the standard condition after the removal from test chamber.

12. High Temperatu	12. High Temperature Loading Test				
Specified Value	Appearance Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value			
Test Methods and Remarks	Temperature Duration Applied current Mounting method Recovery	: 85±2°C : 500+24/-0 hrs : Rated current : Soldering onto PC board : 2 to 3 hrs of recovery under the standard condition after the removal from test chamber.			

13. Bending Strengt	. Bending Strength					
Specified Value	Appearance : No mechanical damage.					
Test Methods and Remarks	Warp : 2mm Testing board : Glass epoxy-resin substrate Thickness : 0.8mm Board R-230 Warp Warp (Unit: mm)					

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Specified Value No separation or indication of separation of electrode. Applied force : 5N Duration : 10 sec. Hooked jig Remarks Board Cross-section

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to 35° C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}\text{C}$ of temperature, 60 to 70% relative humidity and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

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CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE)

PRECAUTIONS

1. Circuit Design

Precautions

◆Operating environment

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

◆Rated current

Rated current of this product is shown in this catalogue, but please be sure to have the base board designed with adequate inspection in
case of the generation of heat becomes high within the rated current range when the base board is in high resistance or in bad heating
conditions.

2. PCB Design

Precautions

◆Land pattern design

1. Please refer to a recommended land pattern.

3. Considerations for automatic placement

Precautions

- ◆Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
 - 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

- Adjustment of mounting machine
 - 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

◆Wave soldering

- 1. Please refer to the specifications in the catalog for a wave soldering
- ◆Reflow soldering
 - 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.
- **♦**Lead free soldering
 - When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, etc. sufficiently.

Precautions

◆Preheating when soldering

 $Heating: The \ temperature \ difference \ between \ soldering \ and \ remaining \ heat \ should \ not \ be \ greater \ than \ 150 ^{\circ}C.$

Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C.

◆Recommended conditions for using a soldering iron

Put the soldering iron on the land-pattern.

Soldering iron's temperature - Below 350°C

Duration - 3 seconds or less

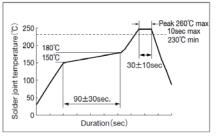
The soldering iron should not directly touch the inductor.

◆Wave, Reflow, Lead free soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

[Recommended reflow condition]





◆Preheating when soldering

- 1. There is a case that products get damaged by a heat shock.
- ◆Recommended conditions for using a soldering iron
 - If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

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5. Handling		
	 ◆Handling 1. Keep the inductors away from all magnets and magnetic objects. ◆Setting PC boards 	
Precautions	1. When setting a chip mounted base board, please make sure that there is no residual stress to the chip by distortion in the board or at screw part.	
	◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.	
	2. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations 1. Please do not give the inductors any excessive mechanical shocks.	
Technical considerations	 ◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Setting PC boards 	
	There is a case that a characteristic varies with residual stress. ◆Breakaway PC boards (splitting along perforations)	
	 Planning pattern configurations and the position of products should be carefully performed to minimize stress. Mechanical considerations There is a case to be damaged by a mechanical shock. 	

6. Storage conditions	
Precautions	◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. •Recommended conditions Ambient temperature −5~40°C Humidity Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, inductors should be used within 6 months from the time of delivery.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.